

# High-speed low-power quad operational amplifier with dual standby position

Datasheet -production data

#### **Features**

■ Low supply current: 4.5 mA

■ High speed: 150 MHz - 110 V/μs

■ Unity gain stability

Low offset voltage: 4 mV

■ Low noise 4.2 nV/√Hz

■ Specified for 600  $\Omega$  and 150  $\Omega$  loads

■ High video performances

Differential gain: 0.03%Differential phase: 0.07°

Gain flatness: 6 MHz, 0.1 dB max. at 10 db

gain

#### **Applications**

Video buffers

A/D converter drivers

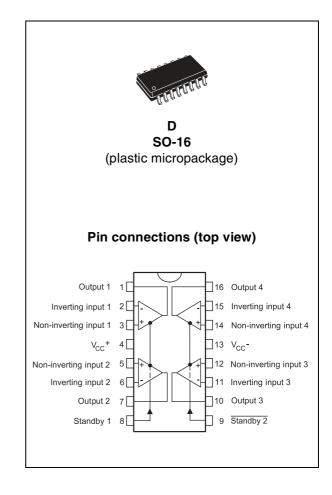
#### **Description**

The TSH95 device is a low-power, high frequency quad operational amplifier designated for high-quality video processing. The device offers an excellent speed consumption ratio with 4.5 mA per amplifier for a 150 MHz bandwidth.

A high slew rate and low noise also make it suitable for high-quality audio applications.

The TSH95 device offers two separate complementary standby pins: "Standby 1" acting on operators 1 and 2, and "Standby 2" acting on operators 3 and 4.

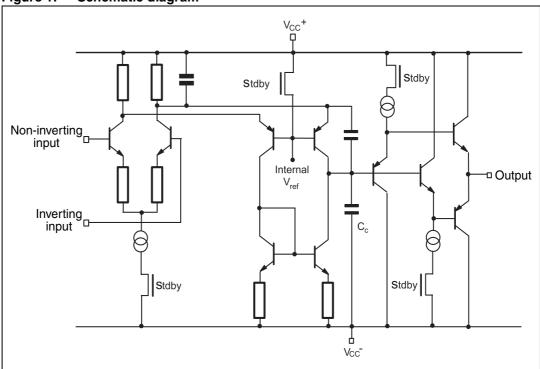
These pins reduce the consumption of the corresponding operators and put the output in a high impedance state.



Schematic diagram TSH95

# 1 Schematic diagram





## 2 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply voltage <sup>(1)</sup>	14	V
V <sub>id</sub>	Differential input voltage <sup>(2)</sup>	±5	٧
V <sub>i</sub>	Input voltage <sup>(3)</sup>	-0.3 to 12	٧
T <sub>oper</sub>	Operating free air temperature range	-40 to +125	°C
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C
ESD	CDM: charged device model <sup>(4)</sup> HBM: human body model <sup>(5)</sup> MM: machine model <sup>(6)</sup>	1.5 2 200	kV kV V

- 1. All voltages values, except differential voltage, are with respect to network ground terminal.
- 2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
- 3. The magnitude of input and output voltages must never exceed  $V_{CC}^+$  +0.3 V.
- 4. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.
- 5. Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5 k $\Omega$  resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- 6. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins are floating.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply voltage	7 to 12	V
V <sub>ic</sub>	Common mode input voltage range	$V_{CC}^-$ +2 to $V_{CC}^+$ -1	٧



Electrical characteristics TSH95

## 3 Electrical characteristics

Table 3. Electrical characteristics at  $V_{CC}+=5$  V,  $V_{CC}-=-5$  V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}+$ ,  $T_{amb}=25$  °C (unless otherwise specified)

Symbol	Parameter		Тур.	Max.	Unit
V <sub>io</sub>	Input offset voltage V <sub>ic</sub> = V <sub>o</sub> = 0 V			4	mV
¥ 10	$T_{min.} \le T_{amb} \le T_{max.}$			6	
I <sub>io</sub>	Input offset current		1	2	μА
10	$T_{min.} \le T_{amb} \le T_{max.}$			5	
I <sub>ib</sub>	Input bias current		5	15	μА
	$T_{min.} \le T_{amb} \le T_{max.}$			20	
I <sub>CC</sub>	Supply current (per amplifier, no load)		4.5	6	mA
	$T_{min.} \le T_{amb} \le T_{max.}$			8	
CMR	Common-mode rejection ratio $V_{ic} = -3 \text{ V to } +4 \text{ V}, V_{o} = 0 \text{ V}$	80 70	100		dB
	$T_{min.} \le T_{amb} \le T_{max.}$		7.5		
SVR	Supply voltage rejection ratio $V_{CC} = \pm 5 \text{ V to } \pm 3 \text{ V}$ $T_{min.} \le T_{amb} \le T_{max.}$	60 50	75		dB
			70		
$A_{vd}$	Large signal voltage gain R <sub>L</sub> = 10 kΩ, $V_0 = \pm 2.5 \text{ V}$ $T_{min.} \le T_{amb} \le T_{max.}$	57 54	70		dB
	High level output voltage V <sub>id</sub> = 1 V	0.			
	$R_{l} = 600 \Omega$	3	3.5		.,
V <sub>OH</sub>	$R_L^- = 150 \Omega$	2.5	3		V
	$T_{min.} \le T_{amb} \le T_{max.}$ $R_L = 150 \Omega$	2.4			
	Low level output voltage V <sub>id</sub> = 11 V				
V <sub>OL</sub>	$R_L$ = 600 $\Omega$ $R_L$ = 150 $\Omega$		-3.5 -2.8	-3 -2.5	V
	$T_{\text{min.}} \le T_{\text{amb}} \le T_{\text{max.}}$ $R_{\text{L}} = 150 \ \Omega$		-2.0	-2.4	
	Output short-circuit current V <sub>id</sub> = ±1 V				
	source	20	36		
I <sub>o</sub>	sink	20	40		mA
	$T_{min.} \le T_{amb} \le T_{max.}$ source sink	15 15			
	Gain bandwidth product	10			
GBP	$A_{VCL} = 100$ , $R_L = 600 \Omega$ , $C_L = 15 pF$ , $f = 7.5 MHz$	90	150		MHz
f <sub>T</sub>	Transition frequency		90		MHz
	Slew rate				
SR	$V_{in} = -2 \text{ to } +2 \text{ V}, R_L = 600 \Omega, C_L = 15 \text{ pF}$	62	110		V/μs
e <sub>n</sub>	Equivalent input voltage noise $R_s = 50 \Omega f = 1 \text{ kHz}$		4.2		nV/√Hz
φm	Phase margin A <sub>VM</sub> = +1		35		Degrees
V <sub>O1</sub> /V <sub>O2</sub>	Channel separation f = 1 MHz to 10 MHz		65		dB
Gf	Gain flatness f = DC to 6 MHz, A <sub>VCL</sub> = 10 dB			0.1	dB
THD	Total harmonic distortion f = 1 kHz, $V_0 = \pm 2.5 \text{ V}$ , $R_L = 600 \Omega$		0.01		%

Table 3. Electrical characteristics at  $V_{CC}$ + = 5 V,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ - = -5 V,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connected to  $V_{CC}$ +,  $V_{CC}$ +,  $V_{CC}$ - = -5 V, pin 8 connected to 0 V, pin 9 connec

Symbol	Parameter	Min.	Тур.	Max.	Unit
ΔG	Differential gain f = 3.58 MHz, $A_{VCL}$ = +2, $R_L$ = 150 $\Omega$		0.03		%
Δφ	Differential phase f = 3.58 MHz, $A_{VCL}$ = +2, $R_{L}$ = 150 $\Omega$		0.07		Degrees

Table 4. Standby mode:  $V_{CC}^+ = 5 \text{ V}$ ,  $V_{CC}^- = -5 \text{ V}$ ,  $T_{amb}^- = 25 ^{\circ}\text{C}$  (unless otherwise specified)

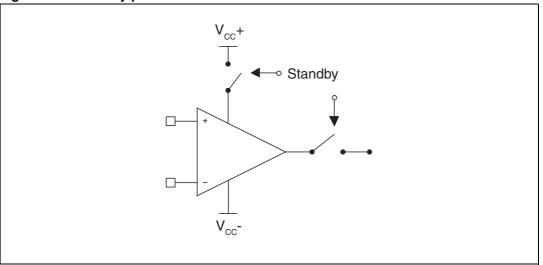
Symbol	Parameter		Тур.	Max.	Unit
V <sub>SBY</sub>	Pin 8/9 threshold voltage for standby mode	V <sub>CC</sub> <sup>+</sup> -2.2	V <sub>CC</sub> + -1.6	V <sub>CC</sub> + -1.0	V
I <sub>CC SBY</sub>	Total consumption:  Pin 8 (Standby 1) = 0, pin 9 ( $\overline{\text{Standby 2}}$ ) = 0  Pin 8 (Standby 1) = 0, pin 9 ( $\overline{\text{Standby 2}}$ ) = 1  Pin 8 (Standby 1) = 0, pin 9 ( $\overline{\text{Standby 2}}$ ) = 0		9.4 9.4 0.8		mA
I <sub>sol</sub>	Input/output isolation (f = 1 MHz to 10 MHz)		70		dB
t <sub>ON</sub>	Time from standby mode to active mode		200		ns
t <sub>OFF</sub>	Time from active mode to standby mode		200		ns
I <sub>D</sub>	Standby driving current		2		рA
l <sub>OL</sub>	Output leakage current		20		рA
I <sub>IL</sub>	Input leakage current		20		рА

Table 5. Standby control pin status

Logi	c input	Status		
Standby 1	Standby 2	Op amps 1 and 2	Op amps 2 and 3	
0	0	Enable	Standby	
0	1	Enable	Enable	
1	0	Standby	Standby	
1	1	Standby	Enable	

Electrical characteristics TSH95

Figure 2. Standby position



To put the device in standby, a logic level must be applied on the standby MOS input. Since ground is a virtual level for the device, the threshold voltage has been referred to  $V_{CC+}$  at  $V_{CC+}$  -1.6 V typical.

In standby mode, the output goes into high impedance in 200 ns. Note that all maximum ratings must still be followed in this mode. This mode leads to a swing limitation while using the device in a signal multiplexing configuration with followers; the differential input voltage must not exceed  $\pm 5$  V, limiting the input swing to 2.5 Vpp.

### 4 Application information

Figure 3. Signal multiplexing

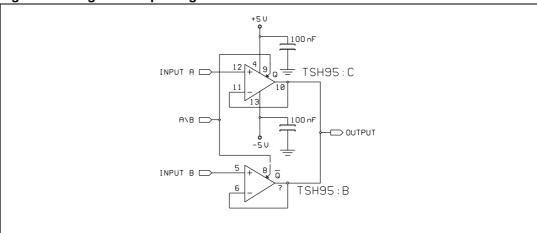
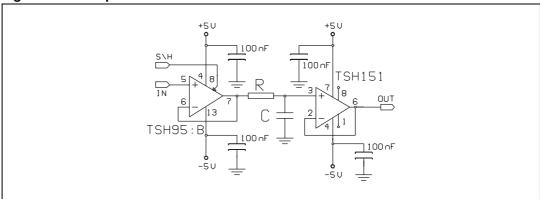


Figure 4. Sample and hold



#### 4.1 Printed circuit layout recommendations

As with any high frequency device, a few rules must be observed when designing the PCB so as to maximize performance.

From the most to the least important points

- Each power supply lead must be bypassed to ground with a 10 nF ceramic capacitor and a 10 μF capacitor placed very close to the device.
- To provide low inductance and low resistance common return, use a ground plane or common point return for power and signal.
- All leads must be wide and as short as possible, especially for the inputs, in order to decrease parasitic capacitance and inductance.
- Use small resistor values to decrease the time constant with parasitic capacitance.
- Choose the smallest possible component sizes (SMD).
- Decrease the capacitor load at the output to avoid degrading the circuit's stability and cause oscillation. You can also add a serial resistor to minimize its influence.

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Figure 5. Large signal follower response

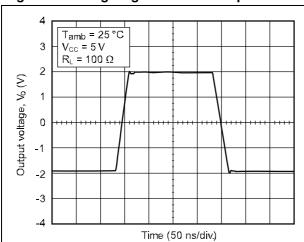


Figure 6. Static open loop voltage gain

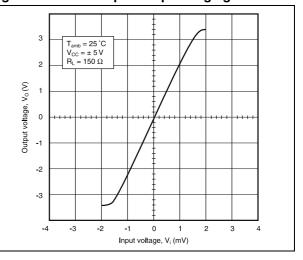
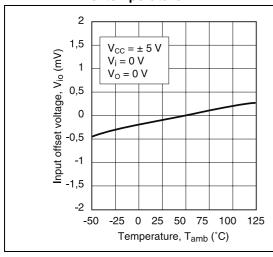


Figure 7. Input offset voltage drift vs. temperature

Figure 8. Small signal follower response



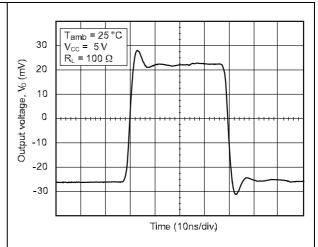
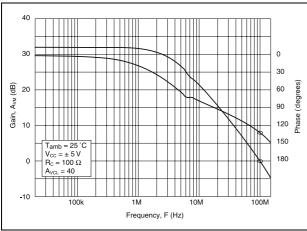
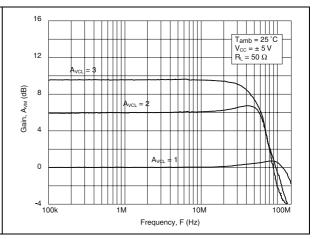


Figure 9. Closed loop frequency response and phase shift

Figure 10. Closed lop frequency response



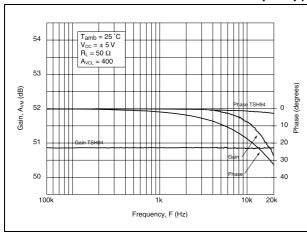


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Figure 11. Audio bandwidth frequency response and phase shift (TSH95 vs. standard 15 MHz audio op amp)

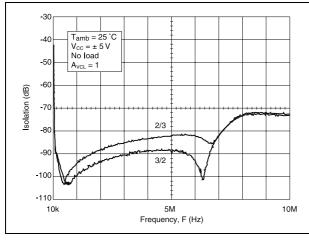
Figure 12. Gain flatness and phase shift vs. frequency



Tamb = 25 °C Phase 4 (seaulapp) aseulapping 100 (seaulapping) aseu

Figure 13. Crosstalk isolation vs. frequency (SO-16 package) (no load)

Figure 14. Crosstalk isolation vs. frequency (SO-16 package) ( $R_L = 150 \Omega$ )



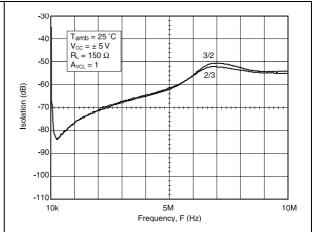
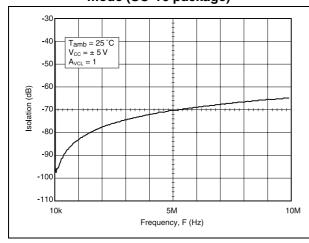
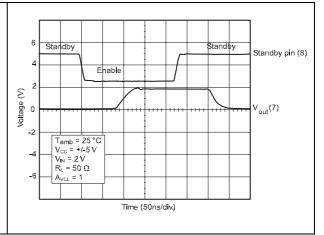


Figure 15. Input/output isolation in standby mode (SO-16 package)

Figure 16. Standby switching





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Figure 17. Signal multiplexing

Figure 18. Differential input impedance vs. frequency

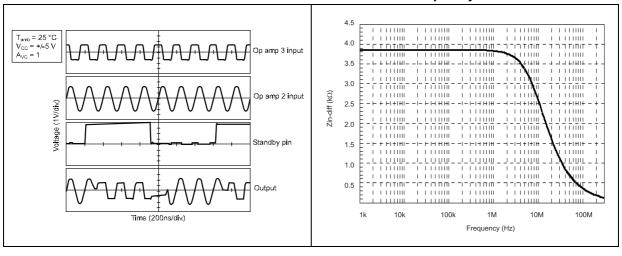
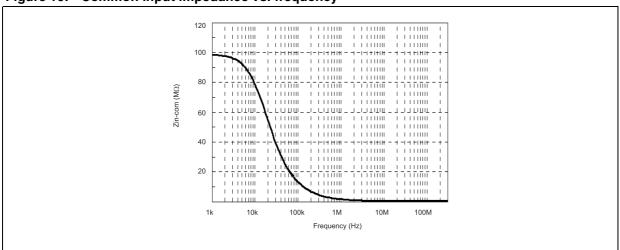


Figure 19. Common input impedance vs. frequency



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#### 5 Macromodel information

```
The information below applies to the TSH95I.
** Standard Linear Ics Macromodels, 1996.
** CONNECTIONS :
* 1 INVERTING INPUT
* 2 NON-INVERTING INPUT
* 3 OUTPUT
* 4 POSITIVE POWER SUPPLY
* 5 NEGATIVE POWER SUPPLY
* 6 STANDBY
.SUBCKT TSH95 1 3 2 4 5 6 (analog)
************
********** switch ***********
.SUBCKT SWITCH 20 10 IN OUT COM
.MODEL DIDEAL D N=0.1 IS=1E-08
DP IN 1 DIDEAL 400E-12
DN OUT 2 DIDEAL 400E-12
EP 1 OUT COM 10 2
EN 2 IN COM 10 2
RFUIT1 IN 1 1E+09
RFUIT2 OUT 2 1E+09
RCOM COM 0 1E+12
.ENDS SWITCH
********** inverter **********
.SUBCKT INV 20 10 IN OUT
.MODEL DIDEAL D N=0.1 IS=1E-08
RP1 20 15 1E+09
RN1 15 10 1E+09
RIN IN 10 1E+12
RIP IN 20 1E+12
DPINV OUT 20 DIDEAL 400E-12
DNINV 10 OUT DIDEAL 400E-12
GINV 0 OUT IN 15 -6.7E-7
CINV 0 OUT 210f
********** AOP ***********
.MODEL MDTH D IS=1E-8 KF=1.809064E-15
CJO=10F
* INPUT STAGE
CIP 2 5 1.000000E-12
CIN 1 5 1.00000E-12
EIP 10 5 2 5 1
EIN 16 5 1 5 1
```

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```
RIP 10 11 2.600000E-01
RIN 15 16 2.600000E-01
RIS 11 15 3.645298E-01
DIP 11 12 MDTH 400E-12
DIN 15 14 MDTH 400E-12
VOFP 12 13 DC 0.000000E+00
VOFN 1314DC 0
FPOL 13 5 VSTB 1E+03
CPS 11 15 2.986990E-10
DINN 17 13 MDTH 400E-12
VIN 17 5 2.000000e+00
DINR 15 18 MDTH 400E-12
VIP 4 18 1.000000E+00
FCP 4 5 VOFP 3.500000E+00
FCN 5 4 VOFN 3.500000E+00
ISTB0 4 5 130UA
FIBP 2 5 VOFP 1.000000E-02
FIBN 5 1 VOFN 1.000000E-02
* AMPLIFYING STAGE
FIP 5 19 VOFP 2.530000E+02
FIN 5 19 VOFN 2.530000E+02
RG1 19 120 3.160721E+03
XCOM1 4 0 120 5 COM SWITCH
RG2 19 121 3.160721E+03
XCOM2 4 0 4 121 COM SWITCH
CC 19 5 2.00000E-09
DOPM 19 22 MDTH 400E-12
DONM 21 19 MDTH 400E-12
HOPM 22 28 VOUT 1.504000E+03
VIPM 28 4 5.000000E+01
HONM 21 27 VOUT 1.400000E+03
VINM 5 27 5.000000E+01
******* ZP ******
RZP1 5 80 1E+06
RZP2 4 80 1E+06
GZP 5 82 19 80 2.5E-05
RZP2H 83 4 10000
RZP1H 83 82 80000
RZP2B 84 5 10000
RZP1B 82 84 80000
LZPH 4 83 3.535e-02
LZPB 84 5 3.535e-02
******
EOUT26 2382 51
```

VOUT 23 5 0

ROUT 26 103 35 COUT 103 5 30.000000E-12 XCOM 4 0 103 3 COM SWITCH DOP 19 25 MDTH 400E-12 VOP 4 25 2.361965E+00 DON 24 19 MDTH 400E-12 VON 24 5 2.361965E+00 \*\*\*\*\*\* STAND BY \*\*\*\*\*\* RMI1 4 111 1E+7 RMI2 0 111 2E+7 RONOFF 6 60 1K CONOGG 60 0 10p RSTBIN 60 0 1E+12 ESTBIN 106 0 6 0 1 ESTBREF 106 107 111 0 1 DSTB1 107 108 MDTH 400E-12 VSTB 108 109 0 ISTB 109 0 1U RSTB 109 110 1 DSTB2 0 110 MDTH 400E-12 XINV 4 0 6 COM INV .ENDS

Table 6. Electrical characteristics with  $V_{CC} = \pm 5 \text{ V}$ ,  $T_{amb} = 25 ^{\circ}\text{C}$  (unless otherwise specified)

Symbol	Conditions	Value	Unit
V <sub>io</sub>		0	mV
A <sub>vd</sub>	$R_L = 600 \Omega$	3.2	V/mV
I <sub>CC</sub>	No load/amplifier	5.2	mA
V <sub>icm</sub>		-3 to 4	V
V <sub>OH</sub>	$R_L = 600 \Omega$	+3.6	V
V <sub>OL</sub>	$R_L = 600 \Omega$	-3.6	V
I <sub>sink</sub>	$V_0 = 0 V$	40	mA
I <sub>source</sub>	$V_0 = 0 V$	40	mA
GBP	$R_L = 600 \Omega C_L = 15 pF$	147	MHz
SR	$R_L = 600 \Omega C_L = 15 pF$	110	V/μs
φm	$R_L = 600 \Omega C_L = 15 pF$	42	Degrees

Package information TSH95

## 6 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: <a href="www.st.com">www.st.com</a>. ECOPACK is an ST trademark.



## 6.1 SO-16 package information

Figure 20. SO-16 package outline

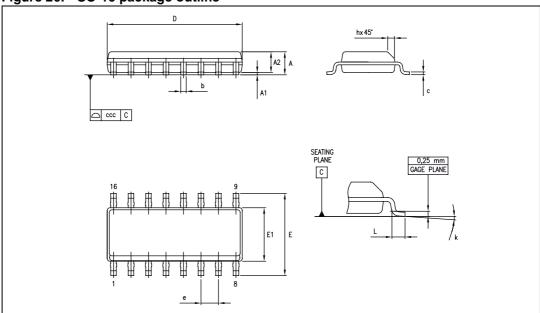


Table 7. SO-16 package mechanical data

	Dimensions					
Cymhal		Millimeters			Inches	
Symbol	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.31		0.51	0.012		0.020
С	0.17		0.25	0.007		0.010
D <sup>(1)</sup>	9.80	9.90	10.00	0.386	0.390	0.394
E	5.80	6.00	6.20	0.228	0.236	0.244
E1 <sup>(2)</sup>	3.80	3.90	4.00	0.150	0.154	0.157
е		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	0		8			
ccc			0.10			0.004

Does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs not to exceed 0.15 mm in total.

Does not include interlead flash or protrusions. Interlead flash or protrusions not to exceed 0.25 mm per side.

Ordering information TSH95

## 7 Ordering information

Table 8. Order codes

Part number	Temperature range	Package	Packing	Marking
TSH95ID		SO-16		TSH95I
TSH95IDT	-40 °C to +125 °C		Tube or	1311931
TSH95IYDT <sup>(1)</sup>		SO-16 (automotive grade)	tape and reel	TSH95IY

Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q 002 or equivalent.

TSH95 Revision history

# 8 Revision history

Table 9. Document revision history

Date	Revision	Changes
01-Nov-2000 1		Initial release.
27-Aug-2009	2	Document format updated.  Updated SO-16 package information in <i>Chapter 6</i> .  Added automotive grade order codes in <i>Table 8</i> .
05-Nov-2012 3		Added conditions to title of <i>Figure 13</i> and <i>Figure 14</i> .  Removed TSH95IYD order code, updated (qualified) status of TSH95IYDT order code in <i>Table 8</i> .  Minor corrections throughout document.

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